

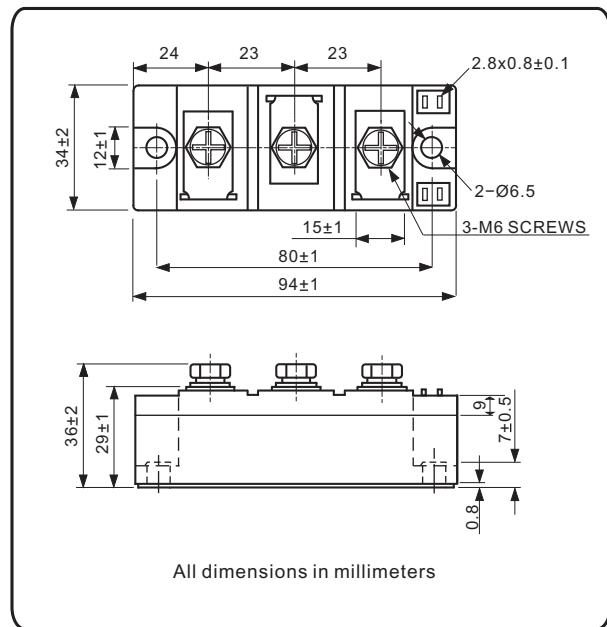
Thyristor/Diode and Thyristor/Thyristor, 200A (New INT-A-PAK Power Modules)



New INT-A-PAK

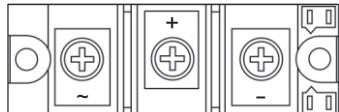
FEATURES

- High voltage
- Electrically isolated by DBC ceramic (Al_2O_3)
- 3500 V_{RMS} isolating voltage
- Industrial standard package
- High surge capability
- Glass passivated chips
- Modules uses high voltage power thyristor/diodes in two basic configurations
- Simple mounting
- UL approved file E320098 
- Compliant to RoHS
- Designed and qualified for multiple level

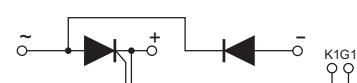
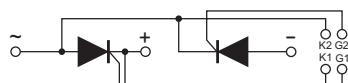

APPLICATIONS

- DC motor control and drives
- Battery charges
- Welders
- Power converters
- Lighting control
- Heat and temperature control

NKT



NKH


PRODUCT SUMMARY

I _{T(AV)}	200 A
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MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
I _{T(AV)}	85 °C	200	A
I _{T(RMS)}	85 °C	314	
I _{TSM}	50 Hz	7200	A
	60 Hz	7560	
I ² t	50 Hz	259	kA ² s
	60 Hz	236	
I ² \sqrt{t}		2592	kA ² \sqrt{s}
V _{DRM} / V _{RRM}	Range	400 to 1600	V
T _J	Range	-40 to 125	°C

ELECTRICAL SPECIFICATIONS

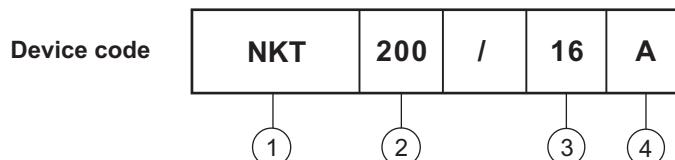
VOLTAGE RATINGS				
Type Number	Voltage Code	V_{RRM}/V_{DRM} , Maximum Repetitive Peak Reverse Voltage V	V_{RSM}/V_{DSM} , Maximum Non-Repetitive Peak Reverse Voltage V	I_{RRM}/I_{DRM} AT 125 °C mA
NKT200 NKH200	04	400	500	30
	08	800	900	
	12	1200	1300	
	14	1400	1500	
	16	1600	1700	

FORWARD CONDUCTION								
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS		
Maximum average on-state current at case temperature	$I_T(AV)$	180° conduction, half sine wave ,50Hz			200	A		
				85	°C			
Maximum RMS on-state current	$I_T(RMS)$	180° conduction, half sine wave ,50Hz , $T_C = 85^\circ C$			314	A		
Maximum peak, one-cycle, on-state non-repetitive surge current	I_{TSM}	$t = 10 \text{ ms}$	No voltage reapplied	Sine half wave, initial $T_J = T_J$ maximum	7200			
		$t = 8.3 \text{ ms}$			7560			
Maximum I^2t for fusing	I^2t	$t = 10 \text{ ms}$	Sine half wave, initial $T_J = T_J$ maximum	100% V_{RRM} reapplied	259	kA ² s		
		$t = 8.3 \text{ ms}$			236			
		$t = 10 \text{ ms}$			181			
		$t = 8.3 \text{ ms}$			165			
		$I^2\sqrt{t}$			2592			
Maximum on-state voltage drop	V_{TM}	$I_{TM} = 600A$, $T_J = 25^\circ C$, 180° conduction			1.7	V		
Maximum forward voltage drop	V_{FM}	$I_{FM} = 600A$, $T_J = 25^\circ C$, 180° conduction			1.4			
Maximum holding current	I_H	Anode supply = 12 V initial $I_T = 30 A$, $T_J = 25^\circ C$			40~150	mA		
Maximum latching current	I_L	Anode supply = 12 V resistive load = 1 Ω Gate pulse: 10 V, 100 μs, $T_J = 25^\circ C$			400			

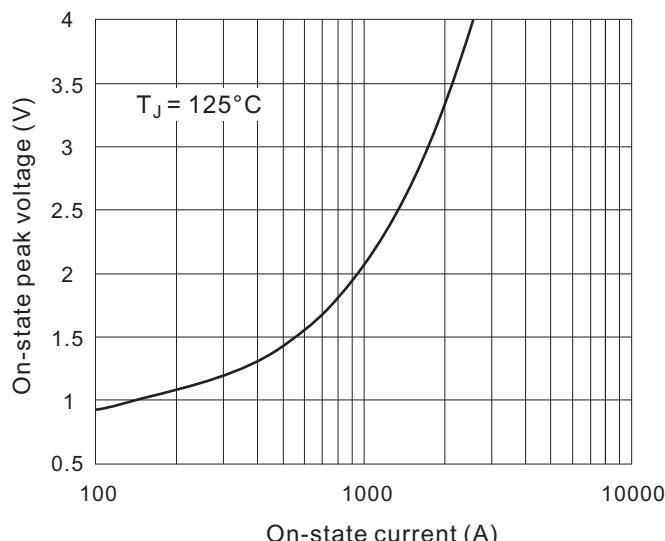
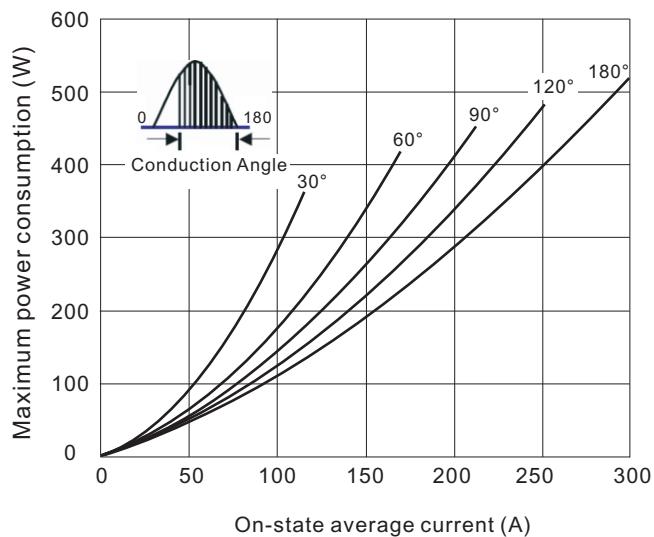
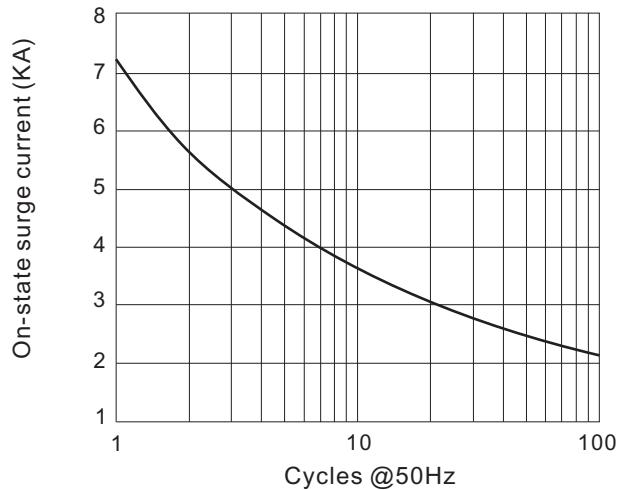
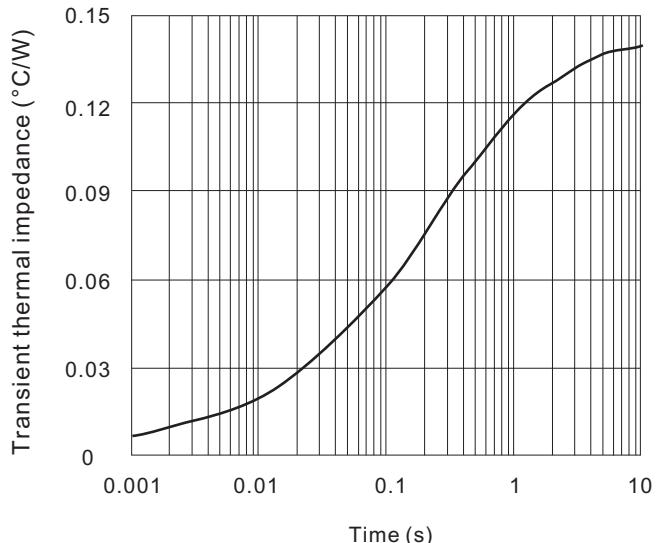
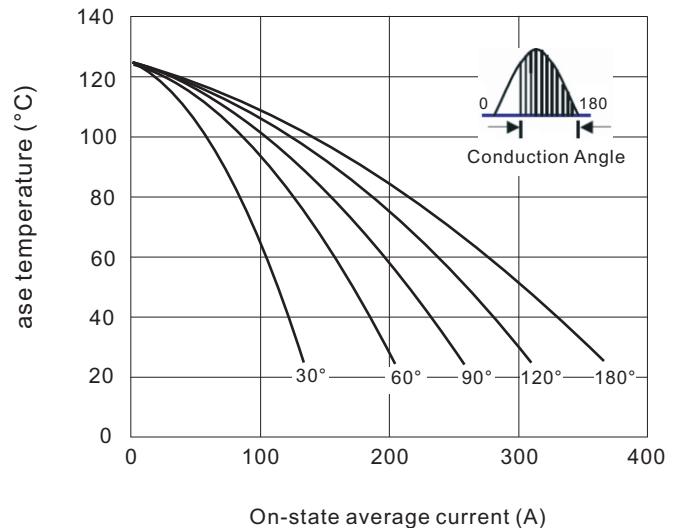
BLOCKING						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum peak reverse and off-state leakage current	I_{RRM} , I_{DRM}	$T_J = 125^\circ C$			30	mA
RMS isolation Voltage	V_{ISO}	50 Hz, circuit to base, all terminals shorted			2500 (1min) 3500 (1s)	V
Critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, exponential to 67 % rated V_{DRM}			500	V/μs

TRIGGERING						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum peak gate power	P _{GM}	$t_p \leq 5 \text{ ms}$, T _J = T _J maximum		10	W	
Maximum average gate power	P _{G(AV)}	$f = 50 \text{ Hz}$, T _J = T _J maximum		3		
Maximum peak gate current	I _{GM}	$t_p \leq 5 \text{ ms}$, T _J = T _J maximum		3	A	
Maximum peak negative gate voltage	- V _{GM}			10		
Maximum required DC gate voltage to trigger	V _{GT}	T _J = 25 °C	Anode supply = 12 V, resistive load; R _a = 1Ω	0.7~1.8	V	
Maximum required DC gate current to trigger	I _{GT}			30~150		
Maximum gate voltage that will not trigger	V _{GD}	T _J = T _J maximum, 66.7% V _{DRM} applied		0.25	V	
Maximum gate current that will not trigger	I _{GD}			10		
Maximum rate of rise of turned-on current	dI/dt	T _J = 25°C , I _{GM} = 1.5A , t _r ≤ 0.5 μs		150	A/μs	

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction operating temperature range	T _J			- 40 to 125	°C
Maximum storage temperature range	T _{Stg}			- 40 to 150	
Maximum thermal resistance, junction to case per junction	R _{thJC}	DC operation		0.14	°C/W
Maximum thermal resistance, case to heatsink per module	R _{thCS}	Mounting surface, smooth , flat and greased		0.025	
Mounting torque ± 10 % IAP to heatsink , M6 busbar to IAP , M6		A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads.		4 to 6	N.m
Approximate weight				220	g
				7.05	oz.
Case style				New INT-A-PAK	

ORDERING INFORMATION TABLE


- [1] - Module type: NKT for (Thyristor + Thyristor) module
NKH for (Thyristor + Diode) module
- [2] - Current rating: I_{T(AV)}
- [3] - Voltage code x 100 = V_{RRM}
- [4] - Assembly type,"A" for soldering type

Nell High Power Products
Fig.1 On-state current vs. voltage characteristic

Fig.3 Power consumption vs. average current

Fig.5 On-state surge current vs cycles

Fig.2 Transient thermal impedance(junction-case)

Fig.4 Case temperature vs. on-state average current

Fig.6 I^2t characteristics
